Hits	Search Text	DB	Time stamp
			i inic stamp
1852	((mask or substrate or plate or wafer or	USPAT;	2003/07/16
	holder) and (fiber near4 (plurality or array))	1	09:32
	and (hole or opening)) and 385/\$6.ccls. and	EPO; JPO	
	align\$6		
157		USPAT;	2003/07/16
	holder) with (fiber near4 (plurality or array))	US-PGPUB;	09:32
	with (hole or opening))) and 385/\$6.ccls.	EPO; JPO	
	and align\$6		
299		USPAT;	2003/07/16
		US-PGPUB;	15:44
		EPO; JPO	
15		USPAT;	2003/07/16
	•	US-PGPUB	15:44
14			2003/07/16
		US-PGPUB;	17:19
		EPO; JPO	
	·		
1			
4224			
1421	303/ 130 ₃ 13 <i>/</i> .CCIS.	USPAT;	2003/07/16
		,	17:20
144035	385/\$6 colo or 209/\$6! 0=0/\$0	•	
	ocorporecis. or oag/sp.ccis. or 359/\$6.ccis.		2003/07/14
ļ		•	16:46
99127	(mask or plate or water or halder) and su		
JJ 121		•	2003/07/14
	and those of opening)	- 1	16:46
i	385/\$6.ccls.	EPO; JPO	000010-11
47569		USPAT;	2003/07/14
47569	303/40.0015.	•	40.40
47569	303/40.0015.	US-PGPUB;	16:46
		US-PGPUB; EPO; JPO	
47569 5410	((mask or plate or wafer or holder) and fiber	US-PGPUB; EPO; JPO USPAT;	2003/07/14
		US-PGPUB; EPO; JPO USPAT; US-PGPUB;	
5410	((mask or plate or wafer or holder) and fiber and (hole or opening)) and 385/\$6.ccls.	US-PGPUB; EPO; JPO USPAT; US-PGPUB; EPO; JPO	2003/07/14 16:46
	((mask or plate or wafer or holder) and fiber	US-PGPUB; EPO; JPO USPAT; US-PGPUB;	2003/07/14
	1852	((mask or substrate or plate or wafer or holder) and (fiber near4 (plurality or array)) and (hole or opening)) and 385/\$6.ccls. and align\$6 (((mask or substrate or plate or wafer or holder) with (fiber near4 (plurality or array)) with (hole or opening))) and 385/\$6.ccls. and align\$6 (((mask or substrate or plate or wafer or holder) same (fiber near4 (plurality or array)) same (hole or opening))) and 385/\$6.ccls. and align\$6 (Us-6522817-\$ or Us-6470123-\$ or Us-6456772-\$ or Us-6456772-\$ or Us-20030123837-\$ or Us-20030028912-\$ or Us-200300128912-\$ or Us-20030016935-\$ or Us-2003002804-\$ or Us-20020197047-\$ or Us-20030012490-\$ or Us-200201772490-\$ or Us-20020131752-\$ or Us-20020131703-\$).did. (mask or substrate or plate or wafer or holder) and (fiber near4 (plurality or array)) and (hole or opening) and ((Us-6522817-\$ or Us-6396995-\$ or Us-4818058-\$).did. or (Us-20030123837-\$ or Us-20030128912-\$ or Us-20030123837-\$ or Us-20030128912-\$ or Us-20030123837-\$ or Us-2003002804-\$ or Us-20030123835-\$ or Us-2003002804-\$ or Us-2003013752-\$ or Us-2003013752-\$ or Us-2003013752-\$ or Us-20020131752-\$ or Us-20020131703-\$).did.) and (bond\$4 or epoxy or glue or cement or adhesive) 385/136,137.ccls.	((mask or substrate or plate or wafer or holder) and (fiber near4 (plurality or array)) and (hole or opening)) and 385/\$6.ccls. and align\$6 157 (((mask or substrate or plate or wafer or holder) with (fiber near4 (plurality or array)) with (hole or opening))) and 385/\$6.ccls. and align\$6 299 (((mask or substrate or plate or wafer or holder) same (fiber near4 (plurality or array)) same (hole or opening))) and 385/\$6.ccls. and align\$6 15 (US-6522817-\$ or US-6396995-\$ or US-2030028912-\$ or US-2030028912-\$ or US-2030028912-\$ or US-20030123837-\$ or US-200301238912-\$ or US-20020172490-\$ or US-20020131703-\$).did. (mask or substrate or plate or wafer or holder) and (fiber near4 (plurality or array)) and (hole or opening) and ((US-6522817-\$ or US-6470123-\$ or US-6456772-\$ or US-6470123-\$ or US-20020131703-\$).did. or (US-20030123837-\$ or US-20030123837-\$ or US-20030123837-\$ or US-20030123837-\$ or US-20030123837-\$ or US-20020131703-\$).did. or (US-20030123837-\$ or US-20030123837-\$

-	14	((mask or plate or wafer or holder) and fiber	USPAT;	2003/07/14
		and (hole or opening)) and 385/\$6.ccls. and	US-PGPUB;	16:52
		align\$6 and guide and (housing or casing)	EPO; JPO	
-	1718	((mask or plate or wafer or holder) and fiber	USPAT;	2003/07/16
		and (hole or opening)) and 385/\$6.ccls. and	US-PGPUB;	09:30
		align\$6 and guide	EPO; JPO	